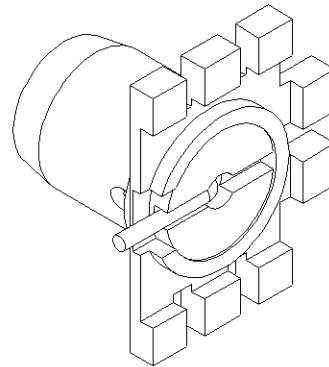
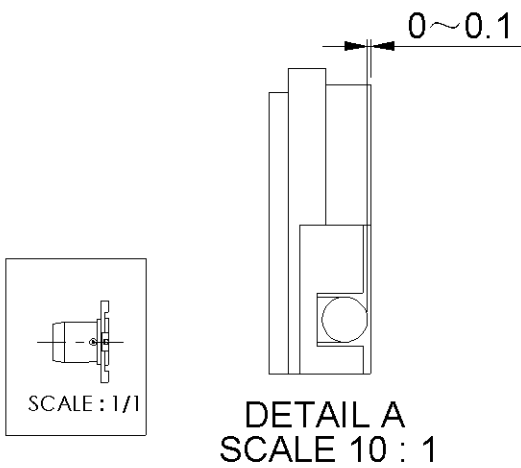
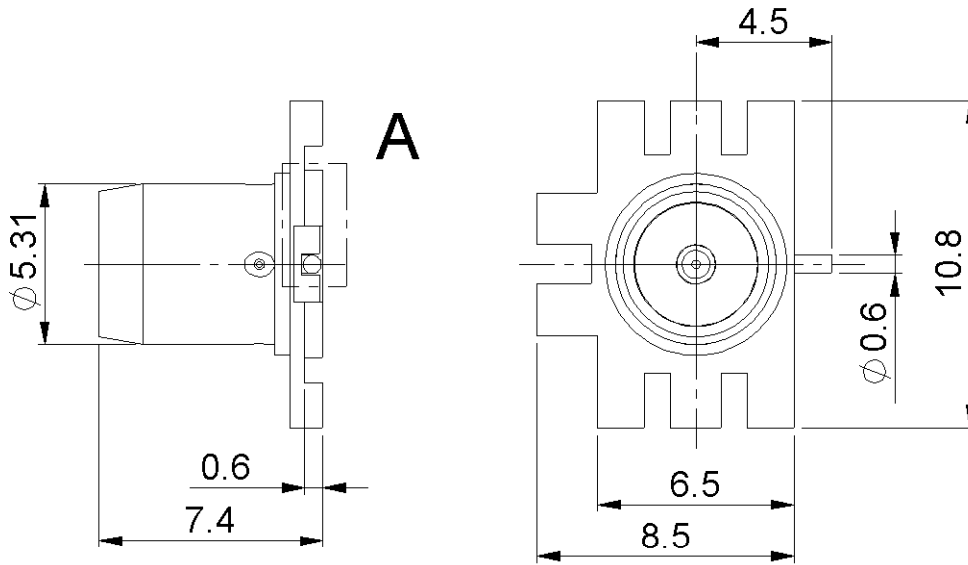


**SMT STRAIGHT PLUG RECEPTACLE**

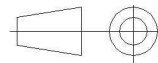
**R128.424.860**

**PACKAGING PER 250**

Series : **BMA-COM**



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATING (µm)
BODY	BRASS	NPGR
CENTER CONTACT	BRASS	GOLD 0.5 OVER NICKEL 2
OUTER CONTACT		
INSULATOR	PTFE	
GASKET		
OTHERS PARTS		
-	-	-
-	-	-

Issue : 0935 B

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



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**PACKAGING**

**SPECIFICATION**

Standard	Unit	Other
<b>250</b>	<b>'W' option</b>	<b>Contact us</b>

**ELECTRICAL CHARACTERISTICS**

**ENVIRONMENTAL**

Impedance	<b>50</b>	$\Omega$
Frequency	<b>0-22</b>	GHz
VSWR	<b>1.02* + 0.0500</b>	x F(GHz) Maxi
Insertion loss	<b>0.07</b>	$\sqrt{F}$ (GHz) dB Maxi
RF leakage	- ( <b>NA</b> )	- F(GHz) dB Maxi
Voltage rating	<b>350</b>	Veff Maxi
Dielectric withstanding voltage	<b>1000</b>	Veff mini
Insulation resistance	<b>5000</b>	M $\Omega$ mini

Operating temperature	<b>-65/+125</b>	$^{\circ}$ C
Hermetic seal	<b>NA</b>	Atm.cm3/s
Panel leakage	<b>NA</b>	

**OTHER CHARACTERISTICS**

Assembly instruction **NA**

Others :  
\*VSWR: 0~3 GHz

**MECHANICAL CHARACTERISTICS**

Center contact retention		
Axial force – Mating end	<b>8</b>	N
Axial force – Opposite end	<b>8</b>	N
Torque	<b>NA</b>	N.cm mini
Recommended torque		
Mating	<b>NA</b>	N.cm
Panel nut	<b>NA</b>	N.cm
Mating life	<b>500</b>	Cycles mini
Weight	<b>1.0180</b>	g

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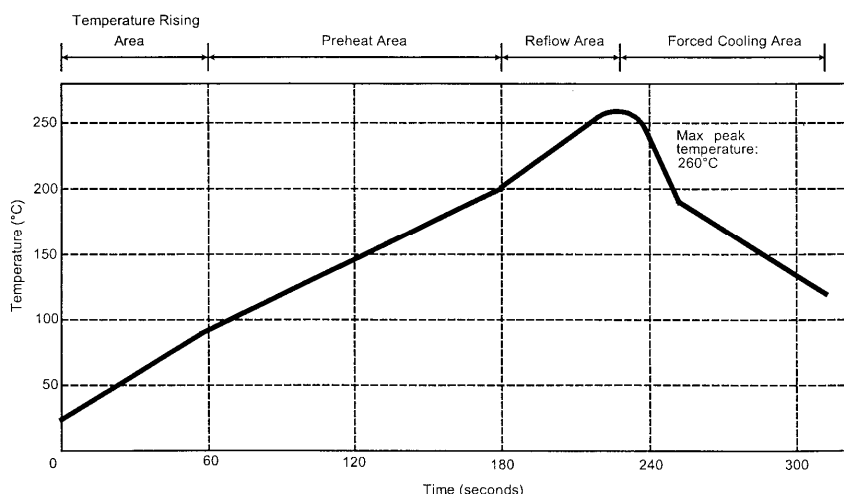
**PACKAGING PER 250**

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**SOLDER PROCEDURE**

1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.  
We advise a thickness of 150 microns ( 5.85 microinch ). Verify that the edges of the zone are clean.
2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.  
Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
3. Soldering by infra-red reflow.  
Below, please find the typical profile to use.
4. Cleaning of printed circuit boards.
5. Checking of solder joints and position of the component by visual inspection.

**TEMPERATURE PROFILE**



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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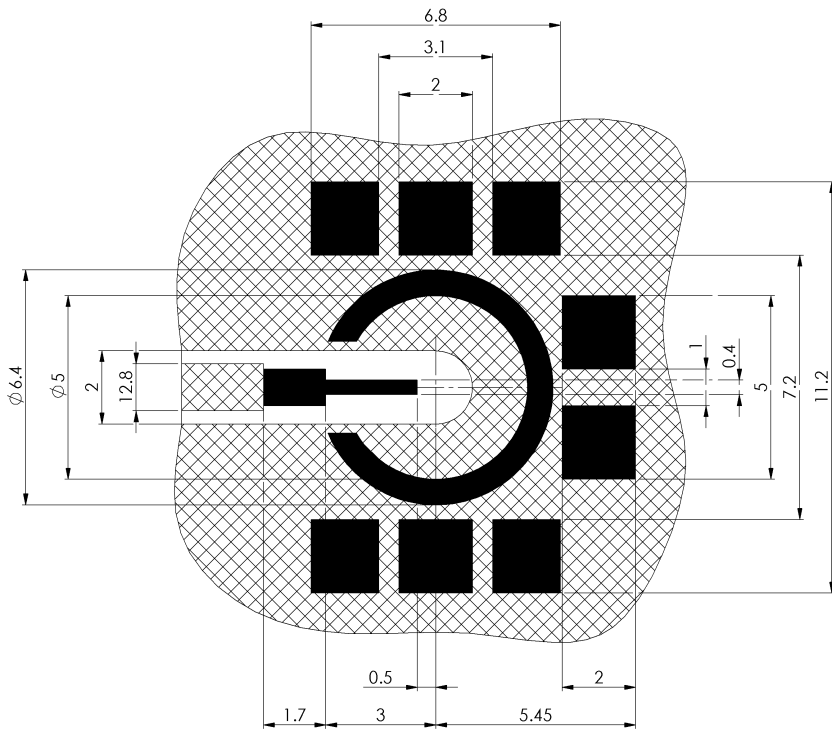
**SMT STRAIGHT PLUG RECEPTACLE**



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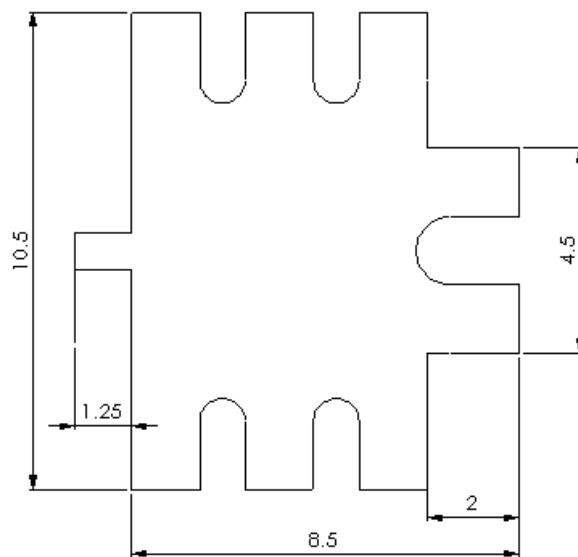
**BMA SERIES - INFORMATIONS**



 Land for solder paste  
 Pattern

**COPLANAR LINE**  
 Pattern and signal are on the same side  
 Thickness of PCB : 1.6mm  
 The material of PCB is the epoxy resin of glass fabrics bacs.(En -4.8)  
 The solder resist should be printed except for the land pattern on the PCB.

**SHADOW OF BMA RECEPTACLE FOR VIDEO CAMERA**



**Issue : 0935 B**

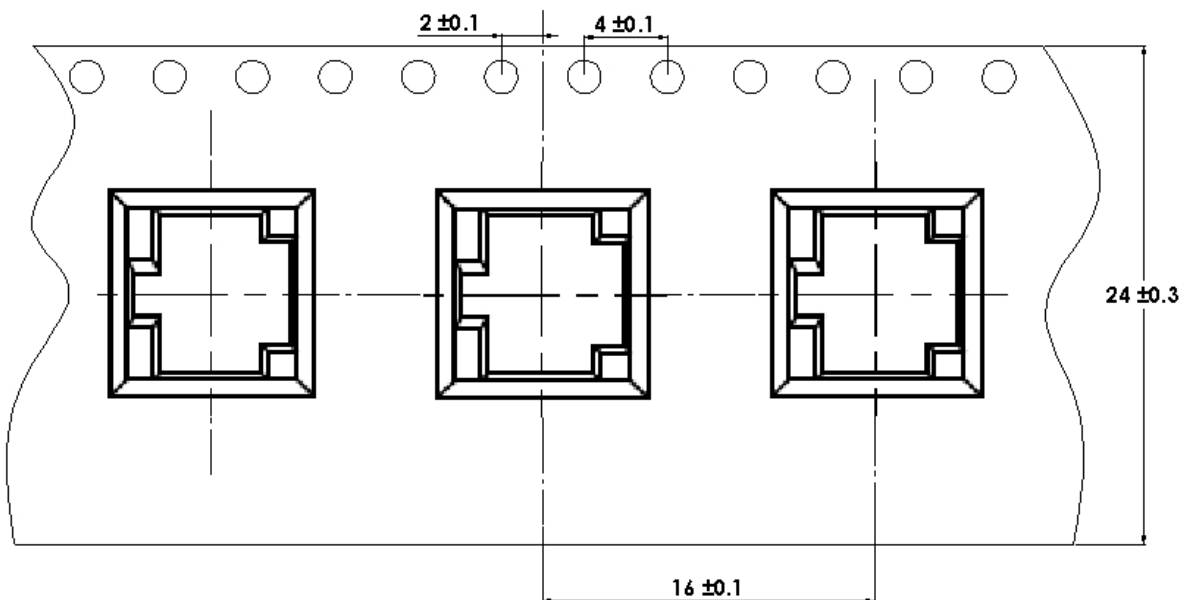
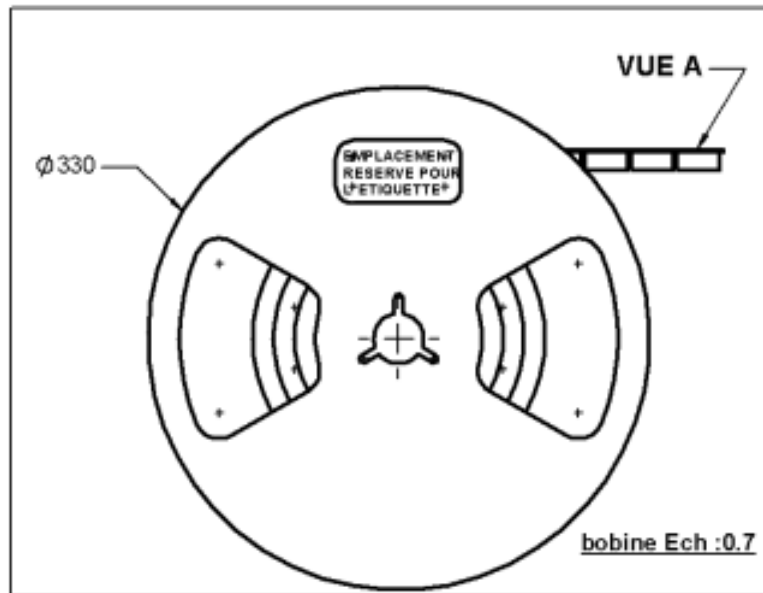
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